

Multilayer Ceramic Chip Capacitors

C1608C0G2A332J080AA



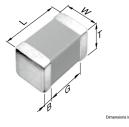






TDK item description C1608C0G2A332JT*****

Applications	Commercial Grade	
Feature	Mid Voltage (100 to 630V)	
Series	C1608 [EIA 0603]	
Status	Production	



Size		
Length(L)	1.60mm +0.15,-0.10mm	
Width(W)	0.80mm +0.15,-0.10mm	
Thickness(T)	0.80mm +0.15,-0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)		
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)	
	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)	
recommended Land Factern (FB)	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)	
Neconinended Land Fattern (FC)	0.60mm to 0.80mm(Reflow Soldering)	

Electrical Characteristics		
Capacitance	3.3nF ±5%	
Rated Voltage	100VDC	
Temperature Characteristic	C0G(0±30ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Caldarian Makhad	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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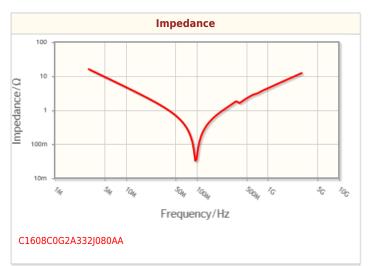


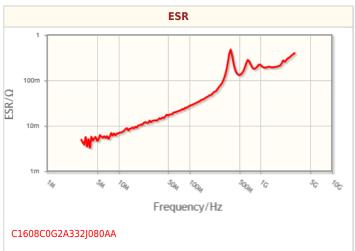


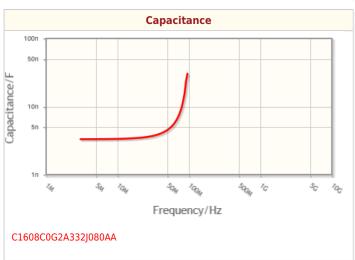


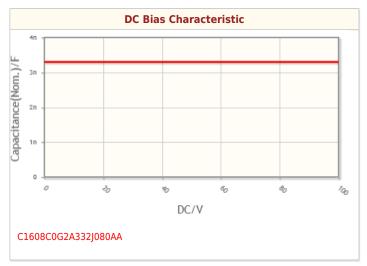


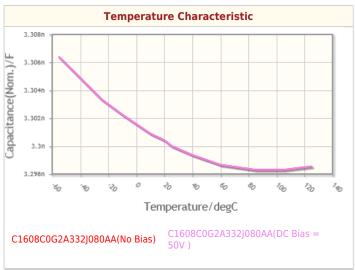
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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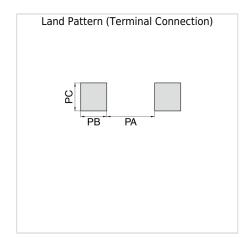








Associated Images



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